

# Empowering Modern Defense : The Crucial Role of Semiconductors in Military and Aerospace Applications

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Allied Market Research published a

report, titled, "Semiconductor in

Military and Aerospace Market by

Component (Sensors, Memory, Opto

Electronics, Logic, Micro, Analog, and

Others), Technology (Surface Mount

Technology and Through-Hole

Technology), End Use (Military and

Aerospace), and Application

(Communication, Navigation, Global

Positioning System (GPS) and

Surveillance, Imaging, Radar and Earth Observation, Munitions, and Others): Global Opportunity

Analysis and Industry Forecast, 2021–2031". According to the report, the global [semiconductor in](#)

[the military and aerospace industry](#) is expected to generate \$6.3 billion in 2021 and is

anticipated to generate \$12.9 billion in 2031, witnessing a CAGR of 7.6% from 2022 to 2031.

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The memory segment to maintain its leadership status throughout the forecast period

Based on components, the memory segment held the highest market share in 2021, accounting for more than one-fourth of the global semiconductor in the military and aerospace market, and is estimated to maintain its leadership status throughout the forecast period. The shift in the trend toward automation and quick adoption of new technologies such as artificial intelligence, and machine learning through the deployment of software-defined and autonomous satellites have notably increased the demand for onboard memory chips. The segment is also projected to manifest the highest CAGR of 9.4% from 2022 to 2031.

The through-hole technology segment to maintain its lead position during the forecast period



Based on technology, the through-hole technology segment accounted for the largest share in 2021, accounting for around three-fifths of the global semiconductor in the military and aerospace market, and is projected to maintain its lead position during the forecast period. Through-hole mount provides stronger mechanical bonds than surface mount technology, making through-hole ideal for semiconductor components that might undergo mechanical stress in the military and aerospace sectors. The segment is also expected to portray the highest CAGR of 7.9% from 2022 to 2031.

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The military segment to maintain its lead position during the forecast period

Based on end use, the military segment accounted for the largest share in 2021, accounting for around three-fourths of the global semiconductor in the military and aerospace market and is projected to maintain its lead position during the forecast period. In the military sector, semiconductor components are utilized in communication equipment, electronic surveillance & countermeasure, unmanned aerial vehicles, missile systems, and others. Additionally, the segment is also expected to portray the highest CAGR of 7.9% from 2022 to 2031.

#### KEY FINDINGS OF THE STUDY :

By component, the memory segment is anticipated to exhibit significant growth in the near future.

By technology, the through-hole technology segment is anticipated to exhibit significant growth in the near future.

By end use, the military segment is anticipated to exhibit significant growth in the near future.

By application, the communication, navigation, global positioning system & surveillance segment is anticipated to exhibit significant growth in the near future.

By region, North America is anticipated to register the highest CAGR during the forecast period.

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Key players operating in the global semiconductor in military and aerospace market include Advanced Micro Devices Inc. (Xilinx Inc.), Analog Devices, Inc., Infineon Technologies AG, Microchip Technology Inc., Northrop Grumman Corporation, NXP Semiconductors NV, ON Semiconductor Corporation, Raytheon Technologies Corporation, Teledyne Technologies Inc., and Texas Instruments Incorporated.

David Correa  
Allied Analytics LLP  
+15038946022 ext.  
[email us here](#)

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